

# μPA1931

## MOS FIELD EFFECT TRANSISTOR

 R07DS0009EJ0103  
 Rev.1.03  
 May 09, 2012

### Description

The μPA1931 is a switching device, which can be driven directly by a 4.5 V power source.

The μPA1931 features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

### Features

- 4.5 V drive available
- Low on-state resistance
  - $R_{DS(on)1} = 65 \text{ m}\Omega \text{ MAX.}$  ( $V_{GS} = -10 \text{ V}$ ,  $I_D = -1.8 \text{ A}$ )
  - $R_{DS(on)2} = 100 \text{ m}\Omega \text{ MAX.}$  ( $V_{GS} = -4.5 \text{ V}$ ,  $I_D = -1.8 \text{ A}$ )

### Ordering Information

Part No.	Lead Plating	Packing	Package
μPA1931TE-T1-AT *1	Pure Sn (Tin)	Tape 3000 p/reel	SC-95 (Mini Mold Thin Type) typ. 0.011 g
μPA1931TE-T2-AT *1			

Note: \*1 This product does not contain Pb.

"-T1" and "-T2" in Part No. indicate the unit orientation.

Marking: UB

### Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$ )

Item	Symbol	Ratings	Unit
Drain to Source Voltage ( $V_{GS} = 0 \text{ V}$ )	$V_{DSS}$	-40	V
Gate to Source Voltage ( $V_{DS} = 0 \text{ V}$ )	$V_{GSS}$	$\mp 20$	V
Drain Current (DC) ( $T_A = 25^\circ\text{C}$ )	$I_{D(DC)}$	$\mp 4.5$	A
Drain Current (pulse) *1	$I_{D(pulse)}$	$\mp 18$	A
Total Power Dissipation	$P_{T1}$	0.2	W
Total Power Dissipation *2	$P_{T2}$	2.0	W
Channel Temperature	$T_{ch}$	150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-55 to +150	$^\circ\text{C}$
Single Avalanche Current *3	$I_{AS}$	3.5	A
Single Avalanche Energy *3	$E_{AS}$	1.2	mJ

Notes: \*1  $P_W \leq 10 \mu\text{s}$ , Duty Cycle  $\leq 1\%$

\*2 Mounted on FR-4 board of 50 mm × 50 mm × 1.6 mm,  $t \leq 5 \text{ sec}$

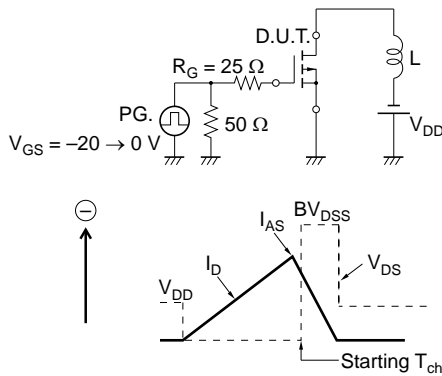
\*3  $T_{ch(peak)} \leq 150^\circ\text{C}$ ,  $R_G = 25 \Omega$

**Electrical Characteristics** ( $T_A = 25^\circ\text{C}$ )

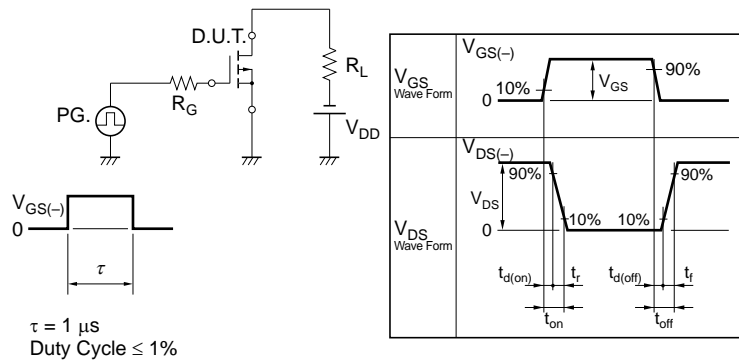
Item	Symbol	MIN.	TYP.	MAX.	Unit	Test Conditions
Zero Gate Voltage Drain Current	$I_{DSS}$			-10	μA	$V_{DS} = -40\text{ V}, V_{GS} = 0\text{ V}$
Gate Leakage Current	$I_{GSS}$			±20	μA	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$
Gate Cut-off Voltage	$V_{GS(off)}$	-1.0	-1.7	-2.5	V	$V_{DS} = -10\text{ V}, I_D = -1\text{ mA}$
Forward Transfer Admittance *1	$ y_{fs} $	2.5			S	$V_{DS} = -10\text{ V}, I_D = -1.8\text{ A}$
Drain to Source On-state Resistance *1	$R_{DS(on)1}$		44	65	mΩ	$V_{GS} = -10\text{ V}, I_D = -1.8\text{ A}$
	$R_{DS(on)2}$		53	100	mΩ	$V_{GS} = -4.5\text{ V}, I_D = -1.8\text{ A}$
Input Capacitance	$C_{iss}$		880		pF	$V_{DS} = -10\text{ V}$
Output Capacitance	$C_{oss}$		150		pF	$V_{GS} = 0\text{ V}$
Reverse Transfer Capacitance	$C_{rss}$		115		pF	$f = 1\text{ MHz}$
Turn-on Delay Time	$t_{d(on)}$		9		ns	$V_{DD} = -20\text{ V}, I_D = -1.8\text{ A}$
Rise Time	$t_r$		4		ns	$V_{GS} = -10\text{ V}$
Turn-off Delay Time	$t_{d(off)}$		74		ns	$R_G = 10\ \Omega$
Fall Time	$t_f$		37		ns	
Total Gate Charge	$Q_G$		20		nC	$V_{DD} = -32\text{ V}$
Gate to Source Charge	$Q_{GS}$		3		nC	$V_{GS} = -10\text{ V}$
Gate to Drain Charge	$Q_{GD}$		5		nC	$I_D = -3.5\text{ A}$
Body Diode Forward Voltage *1	$V_{F(S-D)}$			1.5	V	$I_F = 3.5\text{ A}, V_{GS} = 0\text{ V}$
Reverse Recovery Time	$t_{rr}$		30		ns	$I_F = 3.5\text{ A}, V_{GS} = 0\text{ V}$
Reverse Recovery Charge	$Q_{rr}$		34		nC	$di/dt = 100\text{ A}/\mu\text{s}$

Note: \*1 Pulsed

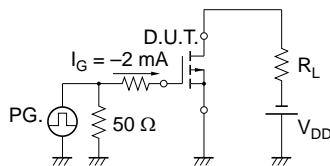
**TEST CIRCUIT 1 AVALANCHE CAPABILITY**



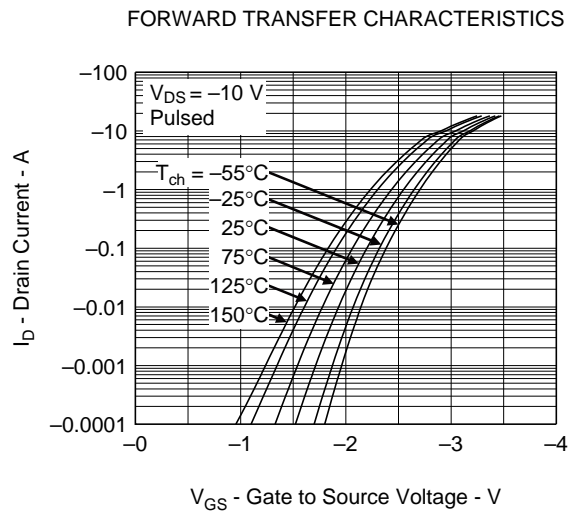
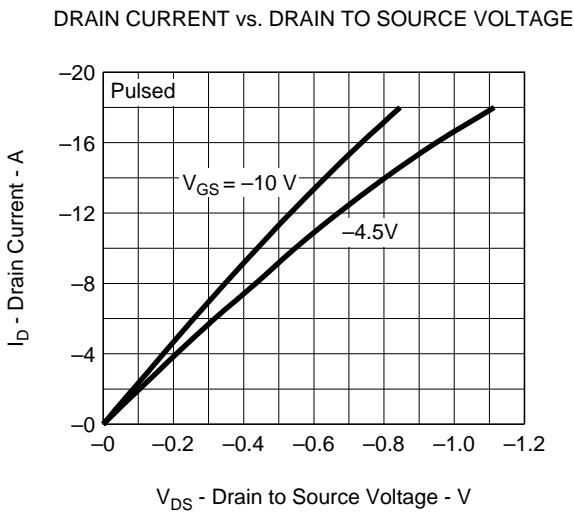
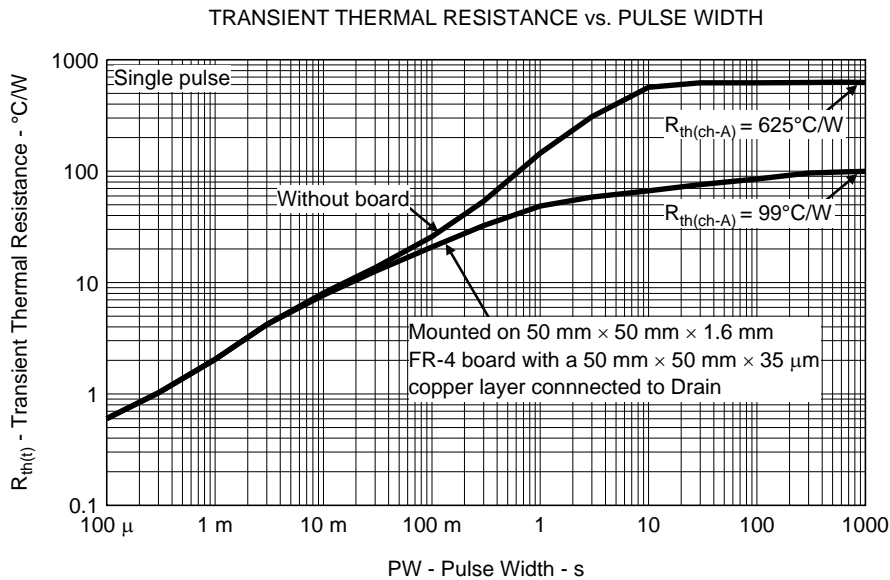
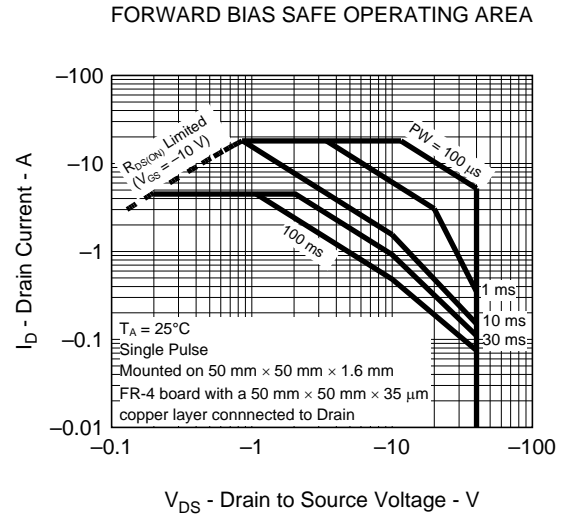
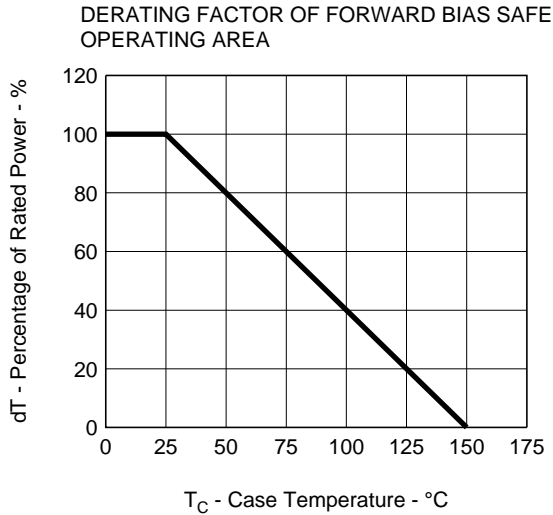
**TEST CIRCUIT 2 SWITCHING TIME**

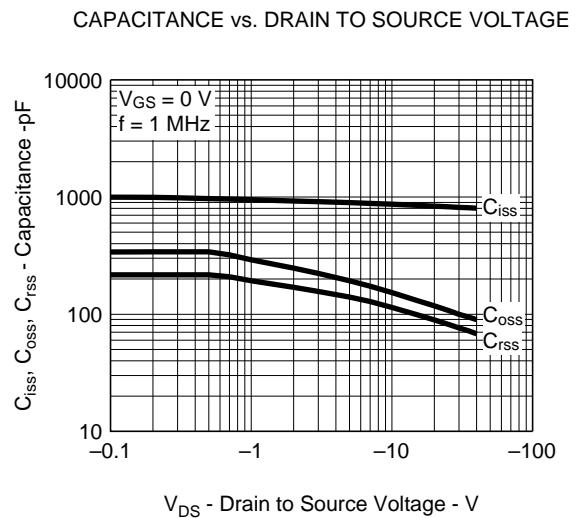
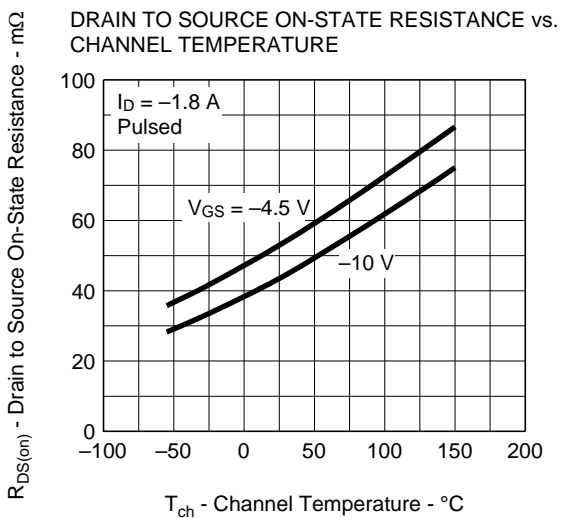
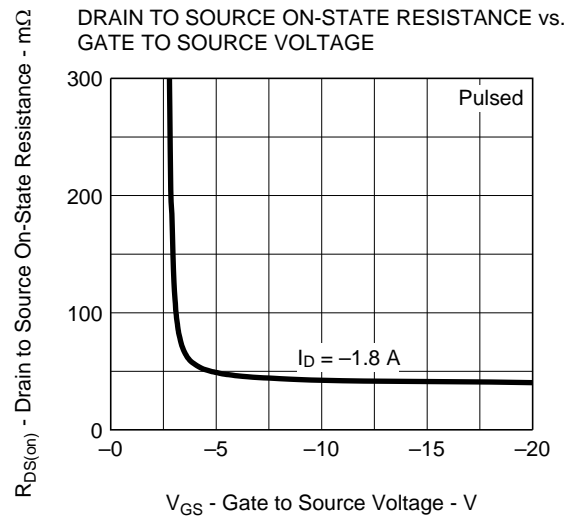
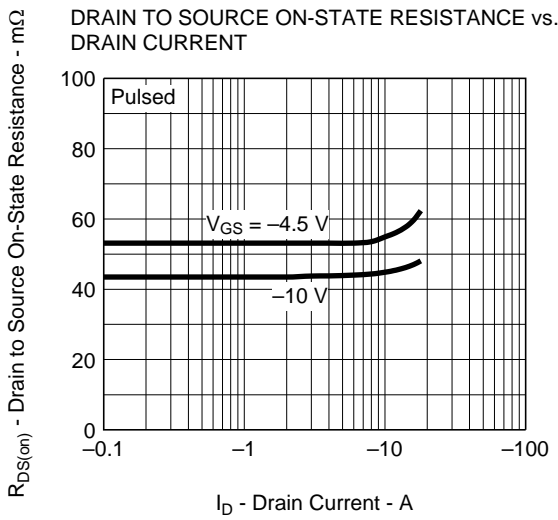
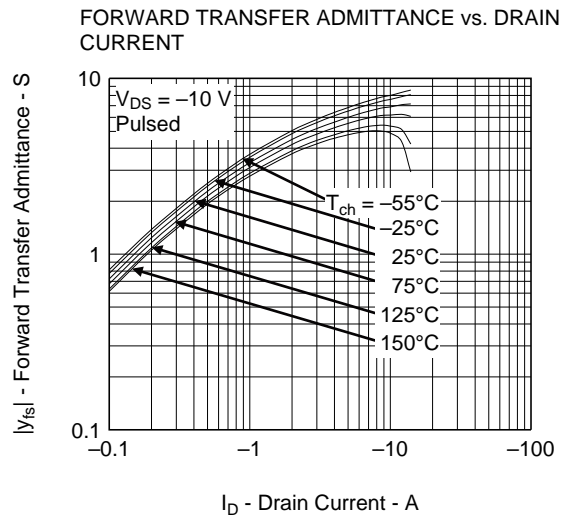
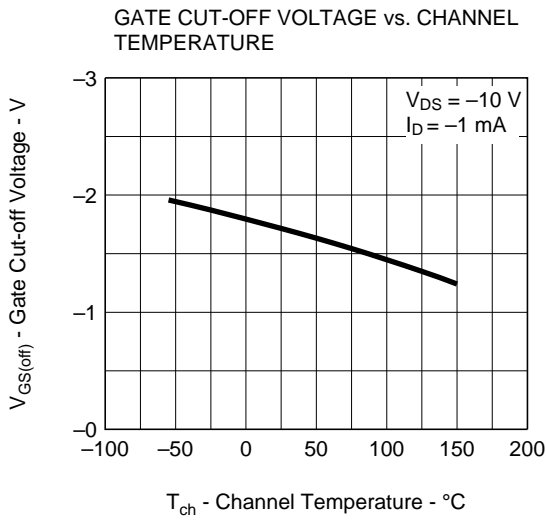


**TEST CIRCUIT 3 GATE CHARGE**

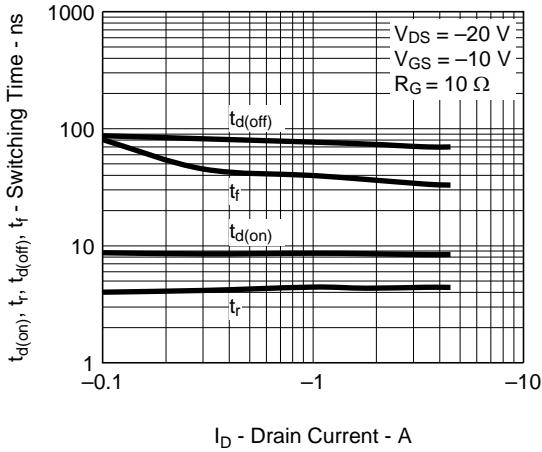


Typical Characteristics (T<sub>A</sub> = 25°C)

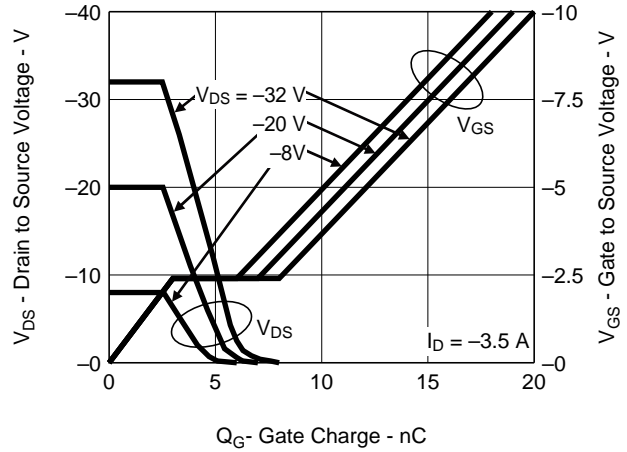




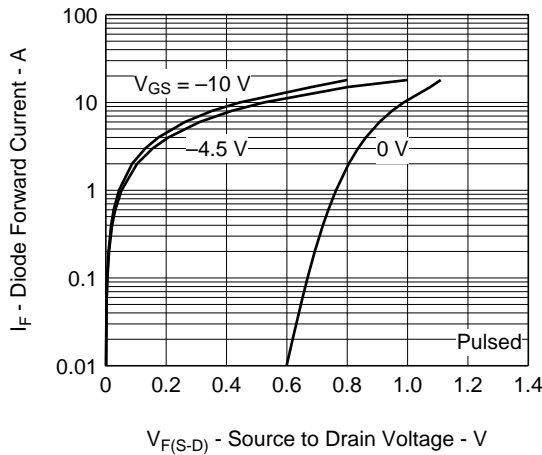
SWITCHING CHARACTERISTICS



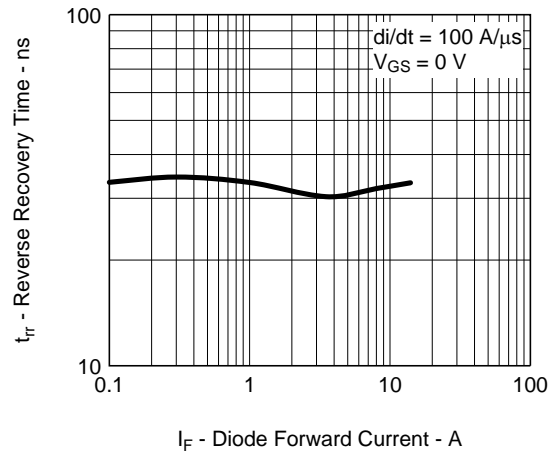
DYNAMIC INPUT/OUTPUT CHARACTERISTICS



SOURCE TO DRAIN DIODE FORWARD VOLTAGE

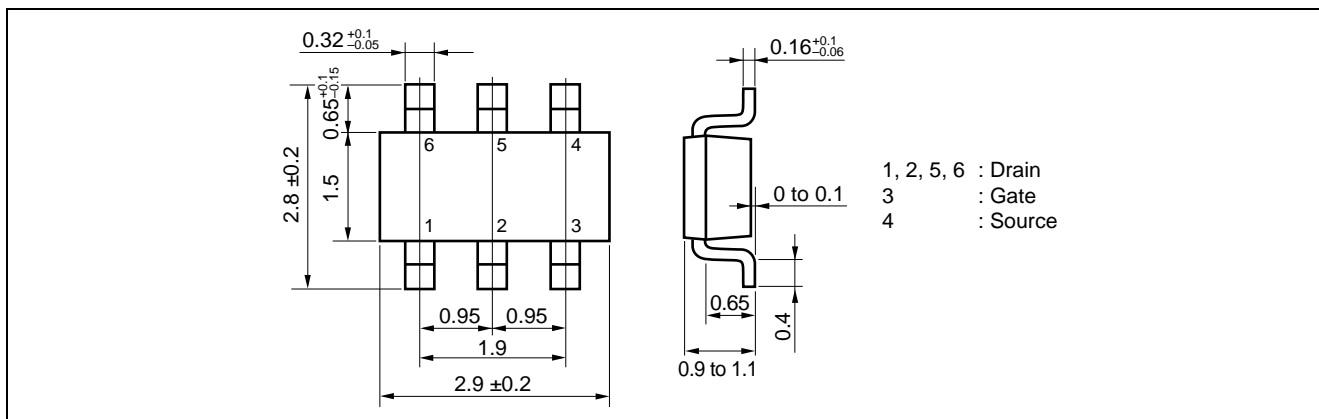


REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT

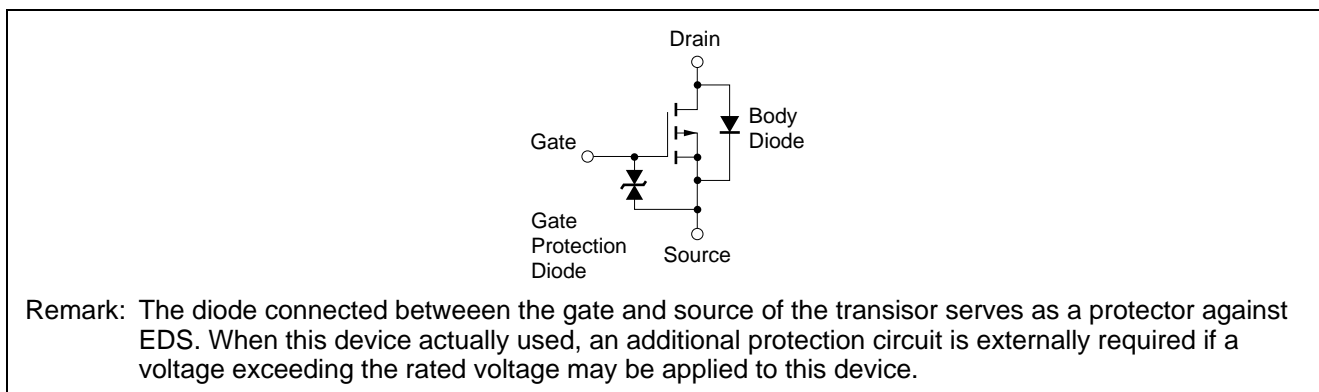


### Package Drawings (Unit: mm)

#### SC-95 (Mini Mold Thin Type)



### Equivalent Circuit



**Revision History****μPA1931 Data Sheet**

Rev.	Date	Description	
		Page	Summary
1.00	Jun 01, 2010	—	First Edition Issued
1.01	Oct 20, 2010	P1	Taping code corrected
1.02	Mar 06, 2012	P1	A type in PT1 item name corrected.
		P3	A type corrected in legend of "TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH" graph.
1.03	May 09, 2012	P1, P2	Minor error correction of letters

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